MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

Broduct data speet

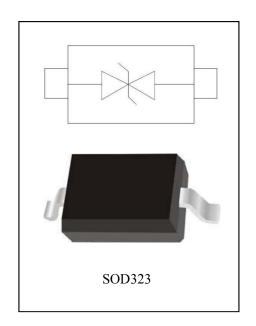


Features

- 150 Watts peak pulse power (tp = 8/20µs)
- Transient protection for high speed data lines to IEC 61000-4-2 (ESD) ±30kV (air), ±30kV (contact) IEC 61000-4-4 (EFT) 40A (5/50ns)
- Working voltages :5V
- Protects one bidirectional line
- Low operating and clamping voltages
- Solid-state silicon avalanche technology



- Notebooks, Desktops, Servers and Video Graphics Cards
- USB Power & Data Line Protection
- Monitors and Flat Panel Displays
- I²C Bus Protection
- Portable Instrumentation
- Set Top Box



Electrical Characteristics@ Ta=25°C unless otherwise

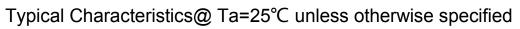
	VRWM @IR		VBR@ImA	Vc@1A	Vc@IPP		CJ
P/N	V	μA	V	V	V	Α	pF
		MAX	MIN	MAX	MAX		MAX
MSESD5V0S1BA	5	1	5.8	11.8	15	10	10

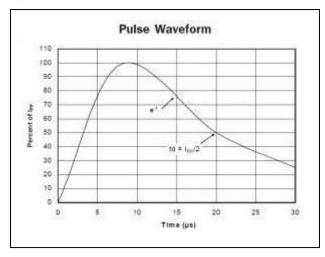
Maximum Rating @ Ta=25°C unless otherwise specified

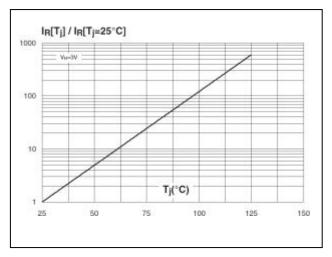
Symbol	Parameter	Ratings	Units
Ррк	Peak Pulse Power (tp = 8/20µs)	150	Watts
TL	Lead Soldering Temperature	260(10sec.)	$^{\circ}$
TJ	Operating Temperature	-55 to +125	$^{\circ}$ C
Тѕтс	Storage Temperature	-55 to +150	$^{\circ}$

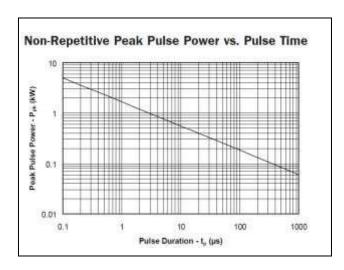


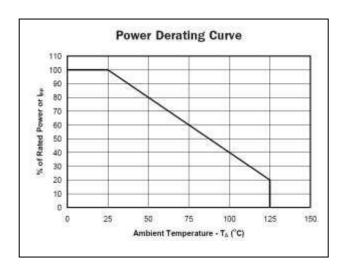






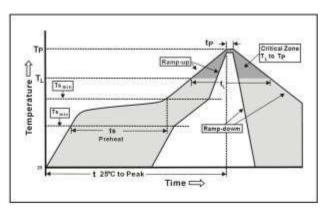




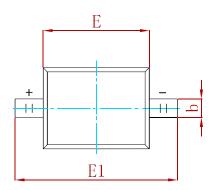


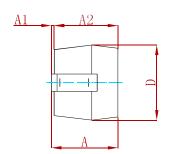
Soldering Parameters

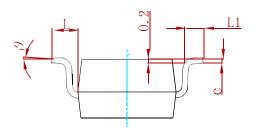
Reflow Condition		Fb – Free assembly	
Pre Heat	-Temperature Min (T _{sown})	150°C	
	- Temperature Max (T _{s(Max)})	200°C	
	-Time (Min to max) (t _j)	60 - 180 secs	
Average (T _L) to pe	amp up rate (Liquidus) Temp ak	3°C/second Max	
T _{s (Max)} to 1	- Ramp-up Rate	3°C/second Max	
Reflow	-Temperature (T _i) (Liquidus)	217°C	
	-Temperature (t _i)	60 - 150 seconds	
Peak Temperature (T _p)		250 °0'-5 °C	
Time within 5°C of actual peak Temperature (t _p)		20 – 40 seconds	
Ramp-down Rate		6°C/second Max	
Time 25°C to peak Temperature (Tp)		8 minutes Max.	
Do not exceed		260°C	



PACKAGE MECHANICAL DATA

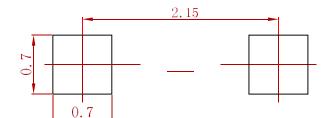






O	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α		1.000		0.039	
A 1	0.000	0.100	0.000	0.004	
A2	0.800	0.900	0.031	0.035	
b	0.250	0.350	0.010	0.014	
С	0.080	0.150	0.003	0.006	
D	1.200	1.400	0.047	0.055	
E	1.600	1.800	0.063	0.071	
E1	2.550	2.750	0.100	0.108	
L	0.475	REF.	0.019	REF.	
L1	0.250	0.400	0.010	0.016	
θ	0°	8°	0°	8°	

Suggested Pad Layout



Note:

- 1. Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
MSESD5V0S1BA	SOD-323	3000



Compiance

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